ABSTRACT OF THE DISCLOSURE

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A gate electrode (la) is formed on the outer peripheral step portion (1') of a semiconductor substrate (1) so as to face a pressure-contact supporting block (6), and a convex contacting portion (lg) is formed on a predetermined position on the surface of the gate electrode to contact the pressure contact supporting block. The surface area of the gate electrode ranging from the inner periphery to a position adjacent to the convex contacting portion, is coated with an insulation film (ld). The convex contacting portion (lg) is formed of a convex portion integral with the gate electrode or formed of another gate electrode (la').